	1	2	3		4		5	6		7		8
ROHS	G103											
A		C±0.3										
-							1.ELECTRICAL SPE	CIFICATIONS:				-
В		1.25 0.3±0					1.0A 125V 1.2 Dielectric Wi 250V AC fo 1.3 Contact Res	thstanding Voltage(or one minute sistance(接触电阻) :				
_				2.4±0.2			100MΩ mi	esistance(绝缘电阻) in				-
		A±0.25		2.4			1.5 Operating Te −40℃ ~ 8 2.MATERIAL SPECIF	emperature(工作温度) 5℃ FICATION・				
С						±0.3	2.1 Insulator Ma	iterial(绝缘体材质): erature Plastic,UL94 :erial(端子材质):	V-0(nature)			
_						2.3	2.3 Solder Tab Phosphor E	Material(焊片脚材质) Bronze	:	▲ Non-	-tooled par	ts
					<u>3.6±0.1</u>	5				No.of	positions	
D		<u>B±0.15</u>			<u><u><u></u><u></u><u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u></u></u>	<u>-</u>				CONTACTS	A E	NSIONS B C
			2.1	1						2		.25 7.55 .50 8.80
										4		.75 10.05
E				0.0			PART NO. LEG			6		.25 12.55 .50 13.80
		<u>08.0</u>		2.5			$\frac{WB1251UR-X}{T}$	T		8	11.75 8	.75 15.05
				- - -				Insulator M Contact Plating	laterial: 5:PA9T :T:Tin all Over	9 10		0.00 16.30 .25 17.55 -
	1.51	1.25±0.05		<u> </u>				NO of Con	tacts: 2 to 16	11 12		.50 18.80 .75 20.05
F	-	B±0.1						Welding Meth	wafer Conn	13	18.00 15	.00 21.30
	RECOM	IENDED PCB								14		5.2522.557.5023.80
		TOLERANCE:±								16	21.75 18	8.75 25.05
GE				DRAWING:			TOLERANCE					
G E D				Hu yc	ntao	.X:=±0.30	.X°:=±2°		СН	IN-B	SAN	
				CHECKED:		.XX:=±0.25 <xx:=±0.15< td=""><td>.XX°:=±1° .XXX°:=±0.5°</td><td></td><td>electro</td><td>onics (H.K.</td><td></td><td></td></xx:=±0.15<>	.XX°:=±1° .XXX°:=±0.5°		electro	onics (H.K.		
B				Tony	UN	NIT: MM	PROJECTION:		N: 1.25mm Pitch	o Sido Entre	Tupe SM	т - Г
НА				APPROVAL:	SC	ALE: N/A		PART NO:				REV: 1.0
	DATE D	ESCRIPTION	APPROVAL	Yang	jie SF	IEET: 1/1		CUSTOMER		51UR-XXT5	(SIZE: A4
	1	2	3		4	,	5	6		7		8

B C D <lid< li=""></lid<>	B IELECTRAL SPECTRANSE B IELECTRAL SPECTRANSE C IELECTRAL SPECTRANSE <td< th=""><th>B I DECINCL SPECIALOS C D C D C D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D C D D D C D D D C D D D C D C D C D C D D D D D D D D D D D D D D D</th><th>E 1000000000000000000000000000000000000</th><th>B I LECTRICL SPECTIONS C A40.20 B I Stato Lucation C A40.20 I Stato Lucation I Stato Lucation C A40.20 I Stato Lucation I Stato Lucation Stato Lucation I Stato Lucation I Stato I Stato I Stato Lucation I Stato I Stato I Stato I Stato I Stato I Stato I Stato I Stato <th>ROHS</th><th>1 S G103</th><th>2</th><th></th><th>3</th><th>l</th><th>4</th><th> 5</th><th>1 6</th><th>I</th><th>7</th><th>I</th></th></td<>	B I DECINCL SPECIALOS C D C D C D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D D C D D D C D D D C D D D C D C D C D C D D D D D D D D D D D D D D D	E 1000000000000000000000000000000000000	B I LECTRICL SPECTIONS C A40.20 B I Stato Lucation C A40.20 I Stato Lucation I Stato Lucation C A40.20 I Stato Lucation I Stato Lucation Stato Lucation I Stato Lucation I Stato I Stato I Stato Lucation I Stato I Stato I Stato I Stato I Stato I Stato I Stato I Stato <th>ROHS</th> <th>1 S G103</th> <th>2</th> <th></th> <th>3</th> <th>l</th> <th>4</th> <th> 5</th> <th>1 6</th> <th>I</th> <th>7</th> <th>I</th>	ROHS	1 S G103	2		3	l	4	 5	1 6	I	7	I
D 210 A B 2 4.25 1.25 3 5.50 2.50 4 6.75 3.75 5 8.00 5.00 6 9.25 6.25 7 10.50 7.50 8 11.75 8.75 9 13.00 10.00 1.50 B±0.1 10 14.25 F RECOMMENDED PCB LAYOUT (TOLERANCE:±0.10) Wafer Conn 14 19.25	D 210 E 210 Image: Contact S A B 2 4.25 1.25 3 5.50 5 8.00 6 9.25 B±0.1 Insulator Material: 5:PA9T Insulator Material: 5:PA9T Insulator Material: 5:PA9T NO of Contact Ploting :T:Tin all Over 9 NO of Contact: 2 to 16 10 Insulator Material: 5:PA9T 10 Insulator Material: 5:PA9T 11 Insulator Material: 5:PA9T 10 Insulator Material: 5:PA9T 11 Insulator Material: 5:PA9T 11 Insulator Material: 5:P	D 210 210 E 210 210 Insulator Material: S:PA9T PART NO. LEGEND: WB1251US-XXT5 150 Isou 125±0.05 B±0.1 Insulator Material: S:PA9T Contact: Plating (T:Tin all Over NO of Contact: 2 to 16 Welding Method:US-SMT90' Wafer Canne G D C DRAWING: Hu yatao C CHECKED:	D 210 PART NO. LEGEND: B = 0.1 PART NO. LEGEND: WB1251US-XX15 Isso 1.2540.05 B = 0.1 RECOMMENDED PCB LAYOUT (TOLERANCE:±0.10) Insulator Material: 5:PAPT (TOLERANCE:±0.10) Insulator Material: 5:PAPT (TOLERANCE:±0.10) G E DRAWING: NO of Contact:US-SMT90' Weter Conn NO of Contact:US-SMT90' Weter Conn G E DRAWING: NU of Contact:US-SMT90' Weter Conn X:=±2' XX:=±0.25 X:=±2' XX:=±0.25 X:=±2' XX:=±0.5' Image: Chercherchercherchercherchercherchercherc	D 2.12 2.12 4.12 1.22 4.22 1.22 4.22 1.22 4.22 1.22 4.22 1.22 4.22 1.22 4.22 1.22 4.22 1.22 4.22 1.22 1.22 4.22 1.22 4.22 1.25 4.25 1.25 4.25 1.25 4.25 1.25 4.25 1.25 4.25 1.25 <t< td=""><td></td><td></td><td>□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □</td><td></td><td></td><td>4.8±0.2</td><td>3.9±03</td><td> 1.1 Rated currer 1.0A 125V 1.2 Dielectric Wi 250V AC fo 1.3 Contact Res 20mΩ ma; 1.4 Insulation Re 100MΩ mi 1.5 Operating Te -40°C ~ 8 2.MATERIAL SPECIF 2.1 Insulator Ma High Tempe 2.2 Contact Mat Phosphor B 2.3 Solder Tab </td><td>nt and voltage(额定电 AC(r.m.s) thstanding Voltage(前 or one minute istance(接触电阻) : x esistance(绝缘电阻) : n emperature(工作温度) 5℃ FICATION: terial(绝缘体材质): erature Plastic,UL94V erial(端子材质): fronze Material(焊片脚材质):</td><td>中压):</td><td>▲ Non</td><td>-tooled part</td></t<>			□ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □			4.8±0.2	3.9±03	 1.1 Rated currer 1.0A 125V 1.2 Dielectric Wi 250V AC fo 1.3 Contact Res 20mΩ ma; 1.4 Insulation Re 100MΩ mi 1.5 Operating Te -40°C ~ 8 2.MATERIAL SPECIF 2.1 Insulator Ma High Tempe 2.2 Contact Mat Phosphor B 2.3 Solder Tab 	nt and voltage(额定电 AC(r.m.s) thstanding Voltage(前 or one minute istance(接触电阻) : x esistance(绝缘电阻) : n emperature(工作温度) 5℃ FICATION: terial(绝缘体材质): erature Plastic,UL94V erial(端子材质): fronze Material(焊片脚材质):	中压) :	▲ Non	-tooled part
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B±0.1 Contact Plating :T:Tin all Over 10 14.25 11.25 NO of Contacts: 2 to 16 N0 of Contacts: 2 to 16 12 16.75 13.75 RECOMMENDED PCB LAYOUT (TOLERANCE:±0.10) Wafer Conn 14 19.25 16.75	B±0.1 B±0.1 B±0.1 Contact Plating :T:Tin all Over NO of Contacts: 2 to 16 NO of Contacts: 2 to 16 11 Welding Method:US=SMT90* (TOLERANCE:±0.10) 13 Wafer Conn 14.25 DRAWING: DRAWING:	F B±0.1 B±0.1 (TOLERANCE:±0.10) B±0.1 B±0.1 (TOLERANCE:±0.10) Image: Contact Plating :T:Tin all Over NO of Contacts: 2 to 16 Welding Method:US=SMT90' Wafer Conn Image: Contact Plating :T:Tin all Over NO of Contacts: 2 to 16 Welding Method:US=SMT90' Wafer Conn G E DRAWING: Hu yatao General TOLERANCE Size=0.30 Size=11' XX:=±0.25 General TOLERANCE Size=11' Size=10.30 CHENBAN Size=11' Size=10.30	F B±0.1 B±0.1 RECOMMENDED PCB LAYOUT (TOLERANCE:±0.10) Image: Display the product of the produc	F B±0.1 B±0.1 RECOMMENDED PCB LAYOUT (TOLERANCE:±0.10) Image: Display the product of the produc	-	1.50			1.6				(T5 	aterial: 5:PA9T	5 6 7 8	8.00 5. 9.25 6. 10.50 7. 11.75 8.
		Image: Constraint of the second state of the second sta	G E DRAWING: Hu yatao GENERAL TOLERANCE X:=±0.30 XX:=±0.25 XX:=±0.25 XX:=±0.5* GENERAL TOLERANCE X:=±2* XX:=±0.25 XX:=±0.5* CHIN-BAN electronics (H.K.) co., Itd B CHECKED: Tony UNIT: MM PROJECTION: DESCRIPTION: 1.25mm Pitch Top Entry Type SMT	G E DRAWING: GENERAL TOLERANCE D Hu yatao X:=±0.30 X:=±2' C CHECKED: XX:=±0.15 XX:=±0.5' B CHECKED: UNIT: MM PROJECTION: H APPROVAL: SCALE: N/A Vana iiio QUEET 1/4 PART NO: WB1251US-XXT5	_		B±0.1 RECOMMENDED PO						Contact Plating NO of Cont	:T:Tin all Over acts: 2 to 16 nod:US=SMT90*	11 12 13 14	15.00 12. 16.75 13. 18.00 15. 19.25 16.

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						1.	250V AC for c 3 Contact Resista						
_						1.	20mΩ max 4 Insulation Resis	tance(绝缘电阻) :					-
			ЩЩЩ			1.	100MΩ min 5 Operating Temp	perature(工作温度) :					
С	│ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │			₩]			–25℃ ~ 85℃ ATERIAL SPECIFICA	TION:					C
		B±0.25		\top			1 Insulator Materi PA66,UL94V-00	(nature)		▲ Non-t	ooled par	ts	
_	-			-		2.	2 Applicable wire:	32AWG TO 28AWG		No.of	positions	DIM list:	-
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	С			CHECKED:			PROJECTION:	DESCRIPTION:			,, 1		-+
	В			Tony		: MM			1.25mm	PITCH H	DUSING		
Н	A			APPROVAL:	SCAL	_E: N/A		PART NO:	WB125	1DSH-XX	<p2< td=""><td>REV: 1</td><td> Н</td></p2<>	REV: 1	Н
	NO. DATE	DESCRIPTION	APPROVAL	Yang jie	e Shei	ET: 1/1	$ \qquad \forall \qquad \neg$	CUSTOMER NO			··· —	SIZE:	
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